

ThinkSystem Qualcomm Cloud AI 100 Accelerator Product Guide

The Qualcomm Cloud AI 100 is designed for AI inference acceleration, and addresses the unique requirements in the cloud, including power efficiency, scale, process node advancements, and signal processing. The AI 100 enables data centers to run inference on the edge cloud faster and more efficiently. Qualcomm Cloud AI 100 is designed to be a leading solution for datacenters who increasingly rely on infrastructure at the edge-cloud.

The following figure shows the Qualcomm Cloud AI 100.

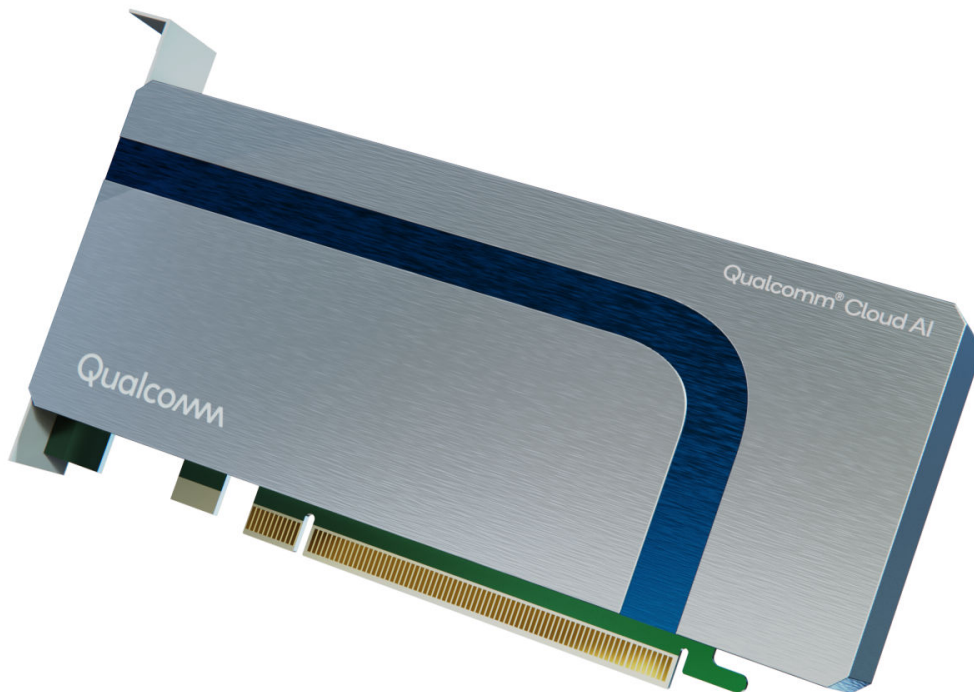


Figure 1. ThinkSystem Qualcomm Cloud AI 100

Did you know?

The ThinkSystem Qualcomm Cloud AI 100 accelerator is offered on ThinkEdge servers to enable customers to deploy AI workloads at the edge of their network. The AI 100 supports over 150 neural networks across multiple categories, including image classification, object detection, semantic segmentation, and natural language processing.

Part number information

The following table shows the part numbers for the GPU.

Table 1. Ordering information

Part number	Feature code	Description	Vendor part number
4X67A84009	BS49	ThinkSystem Qualcomm Cloud AI 100	QAIC-100P-0-MPA001-MT-01-0-BE

The option part number includes the following:

- One Qualcomm Cloud AI 100 (PCIe HHHL-Standard)
- Full height (3U) and Low Profile (2U) adapter brackets
- Documentation

Features

The Qualcomm Cloud AI 100 accelerator supports more than 150 deep learning networks, with strong emphasis on computer vision use cases and natural language processing.

Target applications include:

- Image classification
- Object detection and monitoring
- Semantic segmentation
- Face detection
- Point cloud
- Pose estimation
- Natural language processing (NLP)
- Recommendation systems

The Qualcomm Cloud AI 100 accelerator and accompanying software development kits (SDKs) offer superior power and performance capabilities to meet the growing inference needs of Cloud Data Centers, Edge, and other machine learning (ML) applications. The Cloud AI 100 card is powered by the AIC100 system-on-chip (SoC), which is designed for ML inference workloads.

The Qualcomm Apps and Platform SDKs provide the ability to compile, optimize, and run deep learning models from popular frameworks including:

- PyTorch
- TensorFlow
- ONNX
- Caffe
- Caffe2

Technical specifications

The Qualcomm Cloud AI 100 has the following specifications:

- Low profile form factor
- PCIe 4.0 x8 host interface
- Supports data types: FP32, FP16, INT16, INT8
- Security features include Hardware Root of Trust, Secure boot, Firmware rollback protection

The following table lists the processing specifications and performance of the Qualcomm Cloud AI 100.

Table 2. Specifications

Feature	Specification
Qualcomm AI Cores	16
Peak FP16 Floating Point performance	175 TFLOPS
Peak INT8 Integer Performance	350 TOPS
GPU Memory	16 GB LPDDR4x @ 2133 MHz
Memory Bandwidth	136.5 GB/s
ECC	Yes
Host Interface	PCIe Gen 4, x8 lanes
Form Factor	PCIe low profile (168mm x 69mm), single width
Max Power Consumption	75 W
Thermal Solution	Passive
Display connectors	None

Server support

The following tables list the ThinkSystem servers that are compatible.

Table 3. Server support (Part 1 of 5)

Part Number	Description	AMD V3				2S Intel V3/V4				Multi Node V3	1S V3						
		SR635 V3 (7D9H / 7D9G)	SR655 V3 (7D9F / 7D9E)	SR645 V3 (7D9D / 7D9C)	SR665 V3 (7D9B / 7D9A)	ST650 V3 (7D7B / 7D7A)	SR630 V3 (7D72 / 7D73)	SR650 V3 (7D75 / 7D76)	SR630 V4 (7DG8 / 7DG9)	SR650 V4 (7DGC / 7DGD)	SR650a V4 (7DGC / 7DGD)	SD535 V3 (7DD8 / 7DD1)	SD530 V3 (7DDA / 7DD3)	SD550 V3 (7DD9 / 7DD2)	ST45 V3 (7DH4 / 7DH5)	ST50 V3 (7DF4 / 7DF3)	ST250 V3 (7DCF / 7DCE)
4X67A84009	ThinkSystem Qualcomm Cloud AI 100	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N

Table 4. Server support (Part 2 of 5)

Part Number	Description	4S 8S Intel V3/V4				GPU Rich				Edge								
		SR850 V3 (7D97 / 7D96)	SR860 V3 (7D94 / 7D93)	SR950 V3 (7DC5 / 7DC4)	SR850 V4 (7DJT / 7DJS)	SR860 V4 (7DJQ / 7DJN)	SR670 V2 (7Z22 / 7Z23)	SR675 V3 (7D9Q / 7D9R)	SR680a V3 (7DHE)	SR680a V3 B200 (7DM9)	SR685a V3 (7DHC)	SR780a V3 (7DJ5)	SR680a V4 (7DMK)	SE100 (7DGR)	SE350 (7Z46 / 7D1X)	SE350 V2 (7DA9)	SE360 V2 (7DAM)	SE450 (7D8T)
4X67A84009	ThinkSystem Qualcomm Cloud AI 100	N	N	N	N	N	8	N	N	N	N	N	N	1	N	2	4	3

Table 5. Server support (Part 3 of 5)

Part Number	Description	Super Computing				1S Intel V2	2S Intel V2	AMD V1										
		SC750 V4 (7DDJ)	SC777 V4 (7DKA)	SD665 V3 (7D9P)	SD665-N V3 (7DAZ)	SD650 V3 (7D7M)	SD650-I V3 (7D7L)	SD650-N V3 (7D7N)	ST50 V2 (7D8K / 7D8J)	ST250 V2 (7D8G / 7D8F)	SR250 V2 (7D7R / 7D7Q)	ST650 V2 (7Z75 / 7Z74)	SR630 V2 (7Z70 / 7Z71)	SR650 V2 (7Z72 / 7Z73)	SR635 (7Y98 / 7Y99)	SR655 (7Y00 / 7Z01)	SR645 (7D2Y / 7D2X)	SR665 (7D2W / 7D2V)
4X67A84009	ThinkSystem Qualcomm Cloud AI 100	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N	N

Table 6. Server support (Part 4 of 5)

Part Number	Description	Dense V2				4S V2	8S	4S V1			1S Intel V1			
		SD630 V2 (7D1K)	SD650 V2 (7D1M)	SD650-N V2 (7D1N)	SN550 V2 (7Z69)	SR850 V2 (7D31 / 7D32)	SR860 V2 (7Z59 / 7Z60)	SR950 (7X11 / 7X12)	SR850 (7X18 / 7X19)	SR850P (7D2F / 2D2G)	SR860 (7X69 / 7X70)	ST50 (7Y48 / 7Y50)	ST250 (7Y45 / 7Y46)	SR150 (7Y54)
4X67A84009	ThinkSystem Qualcomm Cloud AI 100	N	N	N	N	N	N	N	N	N	N	N	N	N

Table 7. Server support (Part 5 of 5)

Part Number	Description	2S Intel V1								Dense V1			
		ST550 (7X09 / 7X10)	SR530 (7X07 / 7X08)	SR550 (7X03 / 7X04)	SR570 (7Y02 / 7Y03)	SR590 (7X98 / 7X99)	SR630 (7X01 / 7X02)	SR650 (7X05 / 7X06)	SR670 (7Y36 / 7Y37)	SD530 (7X21)	SD650 (7X58)	SN550 (7X16)	SN850 (7X15)
4X67A84009	ThinkSystem Qualcomm Cloud AI 100	N	N	N	N	N	N	N	N	N	N	N	N

Operating system support

The following table lists the supported operating systems.

Tip: These tables are automatically generated based on data from [Lenovo ServerProven](#).

Table 8. Operating system support for ThinkSystem Qualcomm Cloud AI 100, 4X67A84009

Operating systems	SE450	SE350	SR675 V3	SE360 V2	SE455 V3
Red Hat Enterprise Linux 8.4	Y	Y	N	N	N
Red Hat Enterprise Linux 8.6	Y	Y	Y	Y	Y
Red Hat Enterprise Linux 8.7	Y	Y	Y	N	N
Red Hat Enterprise Linux 8.10	Y	N	Y	Y	Y
Red Hat Enterprise Linux 9.0	Y	Y	Y	Y	Y
Red Hat Enterprise Linux 9.1	Y	Y	Y	N	N
Red Hat Enterprise Linux 9.5	N	N	Y	N	N
Ubuntu 18.04.6 LTS or later with HWE kernel	Y	Y	N	N	N
Ubuntu 20.04.5 LTS or later with HWE kernel	Y	Y	Y	Y	Y
Ubuntu 22.04.2 LTS or later with HWE kernel	N	N	N	N	Y
Ubuntu 22.04.5 LTS or later with HWE kernel	N	N	Y	N	N
Ubuntu 22.04 LTS or later with HWE kernel	Y	Y	Y	Y	N
Ubuntu 24.04 LTS or later with HWE kernel	Y	N	Y	N	N
VMware vSphere Hypervisor (ESXi) 7.0	N	Y	N	N	N

Auxiliary power cables

The Qualcomm Cloud AI 100 does not require an auxiliary power cable.

Regulatory approvals

The Qualcomm Cloud AI 100 has the following regulatory approvals:

- International: IEC 62368-1, EN62368-1 2nd, and 3rd Ed.
- United States of America: FCC
- Canada: ICES-003
- EU/UK: EN 55032, EN55024, EN55035, EN 61000-3-2, EN 61000-3-3, EN62368-1 2nd, and 3rd Ed.
- Taiwan: BSMI
- Korea: KN32 / KN35
- Japan: VCCI
- China: CNS 15663, RoHS
- Australia / New Zealand: AS/NZS CISPR 32
- Logos: cUL, FCC, ICES, RCM, VCCI

Operating environment

The Qualcomm Cloud AI 100 has the following operating characteristics:

- Ambient temperature
 - Operational: 0°C to 50°C (-5°C to 55°C for short term*)
 - Storage: -40°C to 85°C
- Relative humidity:
 - Operational: 5-90%
 - Storage: 5-93%

Warranty

One year limited warranty. When installed in a Lenovo server, the adapter assumes the server's base warranty and any warranty upgrades.

Related publications

For more information, refer to these documents:

- ThinkSystem and ThinkAgile GPU Summary:
<https://lenovopress.lenovo.com/lp0768-thinksystem-thinkagile-gpu-summary>
- ServerProven compatibility:
<https://serverproven.lenovo.com/>
- Qualcomm Cloud AI 100 product page:
<https://www.qualcomm.com/products/technology/processors/cloud-artificial-intelligence/cloud-ai-100>

Related product families

Product families related to this document are the following:

- [GPU adapters](#)

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This document, LP1772, was created or updated on July 18, 2023.

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